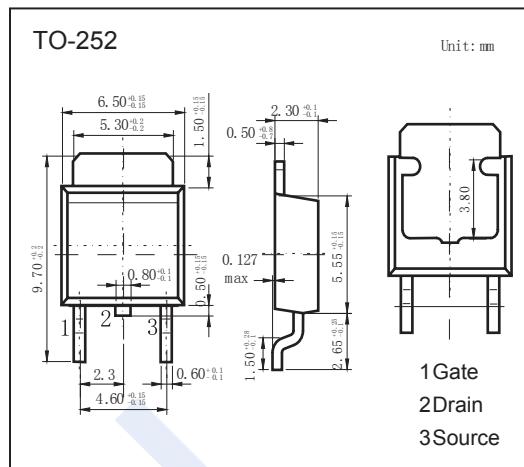
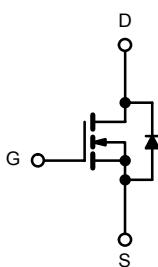


## N-Channel MOSFET

### NDT50N03

#### ■ Features

- $V_{DS} (V) = 30V$
- $I_D = 90 A (V_{GS} = 10V)$
- $R_{DS(ON)} < 5.7m\Omega (V_{GS} = 10V)$
- $R_{DS(ON)} < 7.8m\Omega (V_{GS} = 4.5V)$



#### ■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	
Continuous Drain Current ( $T_j=70^\circ C$ )	$I_c = 25^\circ C$ *1&5	90	A
	$I_c = 70^\circ C$ *1&5	75	
	$I_c = 25^\circ C$ *2&3	30	
	$I_c = 70^\circ C$ *2&3	25	
Pulsed Drain Current	$I_{DM}$	100	mJ
Avalanche Current Pulse	$I_{AS}$	45	
Single Pulse Avalanche Energy	$E_{AS}$	101	
Power Dissipation	$T_c = 25^\circ C$	83	W
	$T_c = 70^\circ C$	58	
	$T_a = 25^\circ C$ *2&3	10	
	$T_a = 70^\circ C$ *2&3	7	
Thermal Resistance.Junction- to-Ambient $t \leq 10sec$ *2&4	$R_{thJA}$	15	°C/W
Thermal Resistance.Junction- to-Case Steady State	$R_{thJC}$	1.8	
Junction Temperature	$T_j$	175	°C
Storage Temperature Range	$T_{stg}$	-55 to 175	

\*1: Based on  $T_C = 25^\circ C$ .

\*2: Surface mounted on 1" x 1" FR4 board.

\*3:  $t = 10$  sec

\*4: Maximum under steady state conditions is 50 °C/W.

\*5: Calculated based on maximum junction temperature. Package limitation current is 50 A.

## N-Channel MOSFET

### NDT50N03

■ Electrical Characteristics  $T_a = 25^\circ C$

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{DSS}$	$I_D=250 \mu A, V_{GS}=0V$	30			V
Zero Gate Voltage Drain Current	$I_{DS(on)}$	$V_{DS}=30V, V_{GS}=0V$			1	$\mu A$
		$V_{DS}=30V, V_{GS}=0V, T_J=55^\circ C$			10	
Gate-Body Leakage Current	$I_{GSS}$	$V_{DS}=0V, V_{GS}=\pm 20V$			$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250 \mu A$	1.2		2.4	V
Static Drain-Source On-Resistance *1	$R_{DS(on)}$	$V_{GS}=10V, I_D=20A$		4.6	5.7	$m\Omega$
		$V_{GS}=4.5V, I_D=20A$		6.2	7.8	
On State Drain Current *1	$I_{D(on)}$	$V_{GS}=10V, V_{DS}=5V$	50			A
Forward Transconductance *1	$g_{FS}$	$V_{DS}=15V, I_D=30A$		70		S
Input Capacitance	$C_{iss}$	$V_{GS}=0V, V_{DS}=15V, f=1MHz$ *2		3800		$pF$
Output Capacitance	$C_{oss}$			615		
Reverse Transfer Capacitance	$C_{rss}$			305		
Gate Resistance	$R_g$	$V_{GS}=0V, V_{DS}=0V, f=1MHz$		0.9	1.4	$\Omega$
Total Gate Charge	$Q_g$	$V_{GS}=10V, V_{DS}=15V, I_D=30A$ *2		62	95	$nC$
				30	45	
Gate Source Charge	$Q_{gs}$	$V_{GS}=4.5V, V_{DS}=15V, I_D=25A$ *2		11		
Gate Drain Charge	$Q_{gd}$			9		
Turn-On DelayTime	$t_{d(on)}$	$V_{GS}=10V, V_{DS}=15V, R_L=0.5 \Omega, R_{GEN}=1 \Omega, I_D=30A$ *2		12	18	$ns$
Turn-On Rise Time	$t_r$			10	15	
Turn-Off DelayTime	$t_{d(off)}$			30	45	
Turn-Off Fall Time	$t_f$			8	12	
Turn-On DelayTime	$t_{d(on)}$	$V_{GS}=4.5V, V_{DS}=15V, R_L=0.6 \Omega, R_{GEN}=1 \Omega, I_D=25A$ *2		26	40	$ns$
Turn-On Rise Time	$t_r$			230	345	
Turn-Off DelayTime	$t_{d(off)}$			25	40	
Turn-Off Fall Time	$t_f$			9	14	
Body Diode Reverse Recovery Time	$t_{rr}$	$I_F=6.7A, dI/dt=100A/\mu s, T_J=25^\circ C$		65	100	$nC$
Body Diode Reverse Recovery Charge	$Q_{rr}$			38	60	
Reverse Recovery Fall Time	$t_a$			50		$ns$
Reverse Recovery Rise Time	$t_b$			15		
Maximum Body-Diode Continuous Current	$I_S$	$T_c=25^\circ C$ *3			55	$A$
Pulse Diode Forward Current *1	$I_{SM}$				100	
Diode Forward Voltage	$V_{SD}$	$I_S=6.7A, V_{GS}=0V$		0.9	1.5	V

\*1: Pulse test; pulse width  $\leq 300 \mu s$ , duty cycle  $\leq 2\%$ .

\*2: Guaranteed by design, not subject to production testing.

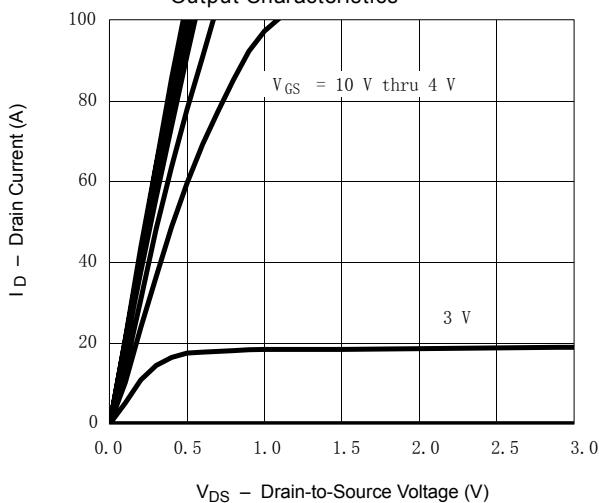
\*3: Calculated based on maximum junction temperature. Package limitation current is 50 A.

## N-Channel MOSFET

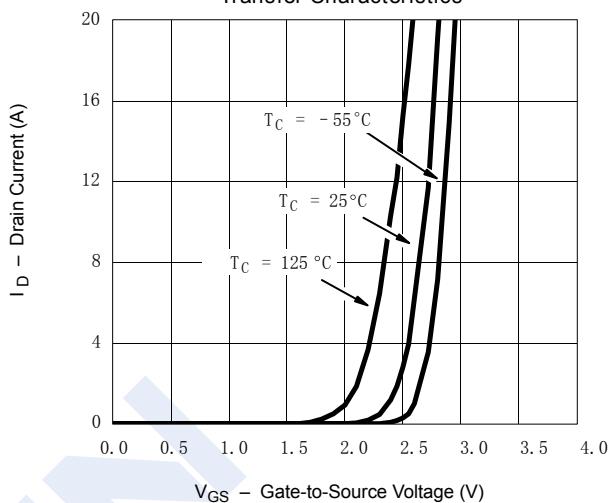
NDT50N03

## ■ Typical Characteristics

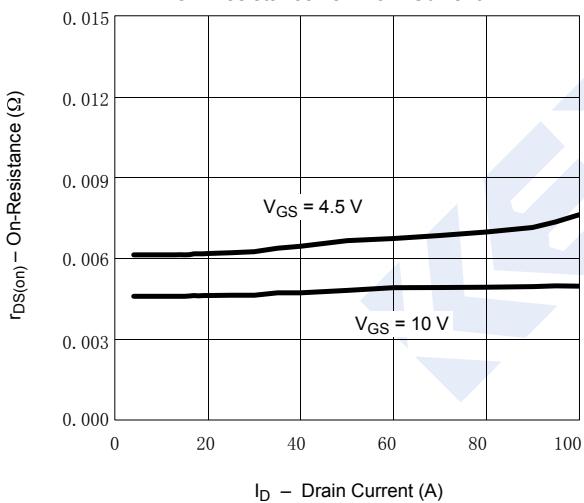
## Output Characteristics



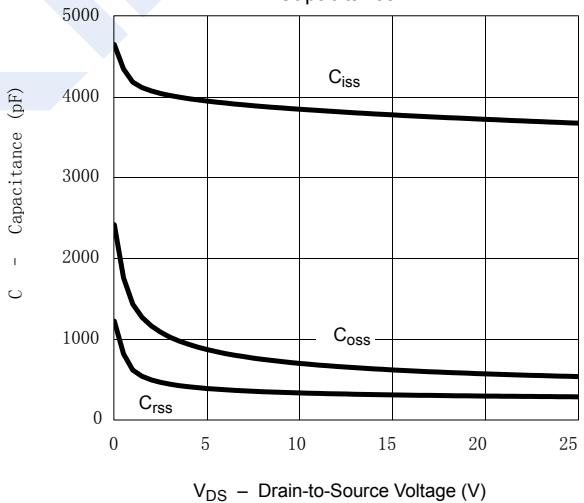
## Transfer Characteristics



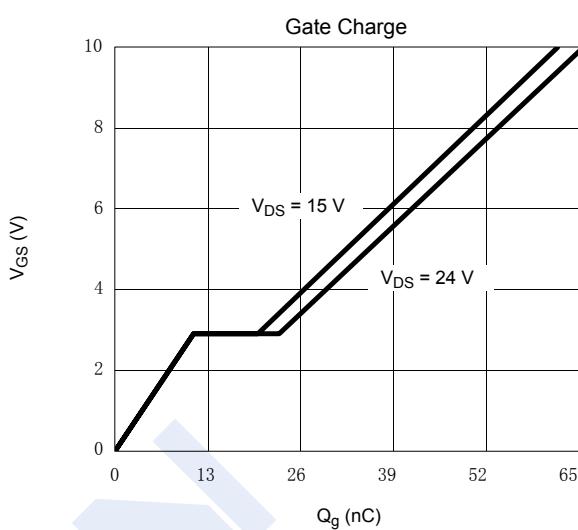
## On-Resistance vs. Drain Current



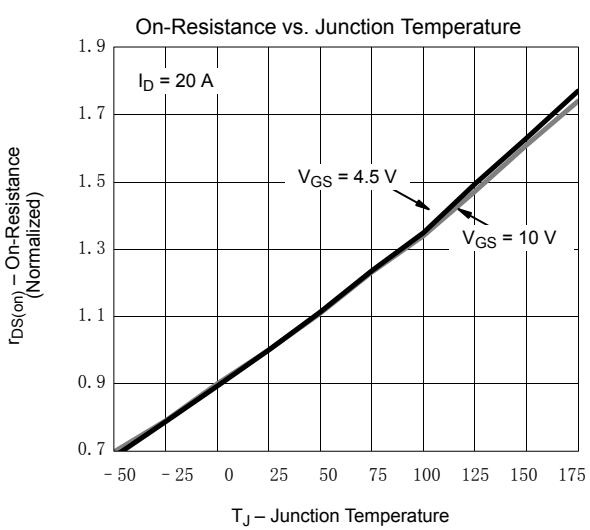
## Capacitance



## Gate Charge



## On-Resistance vs. Junction Temperature

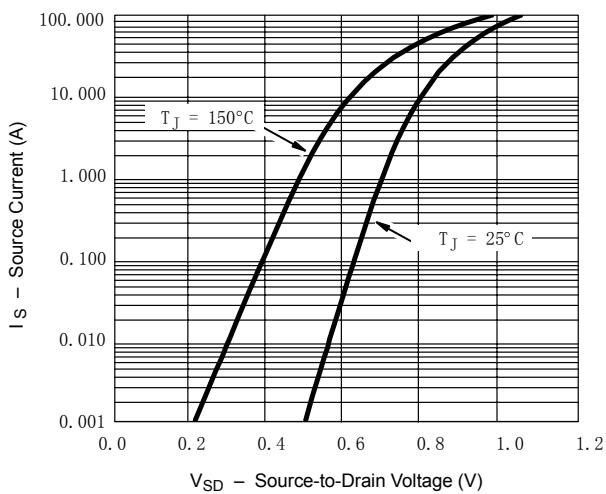
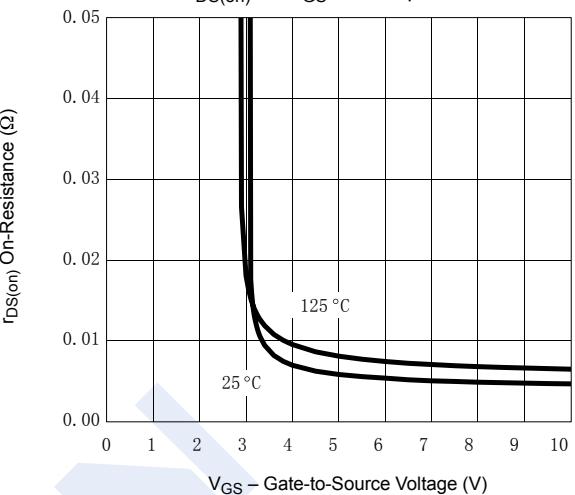


## N-Channel MOSFET

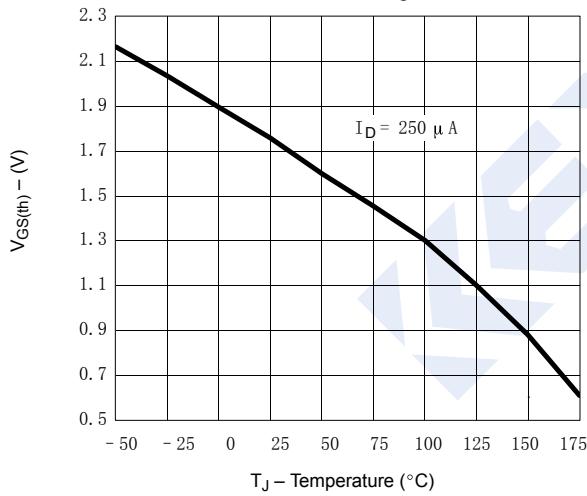
## NDT50N03

## ■ Typical Characteristics

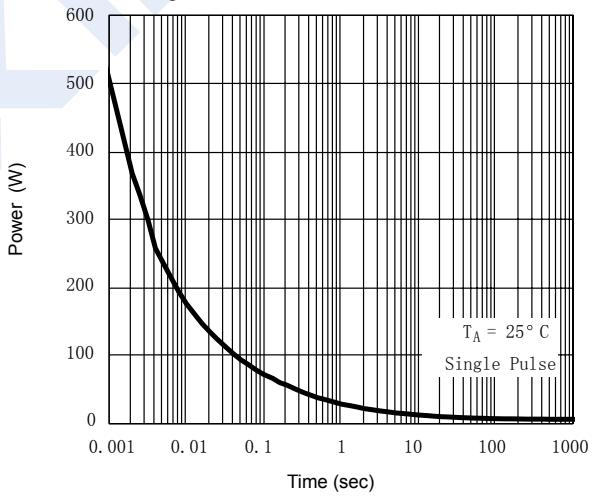
Source-Drain Diode Forward Voltage

 $r_{DS(on)}$  vs  $V_{GS}$  vs. Temperature

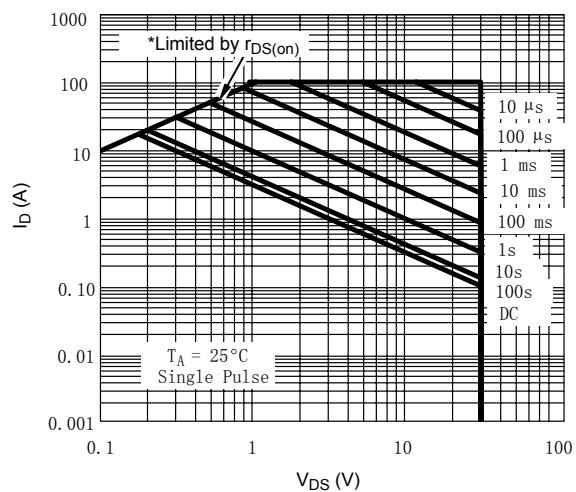
Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area



\* $V_{GS} >$  minimum  $V_{GS}$  at which  $r_{DS(on)}$  is specified

## N-Channel MOSFET

### NDT50N03

#### ■ Typical Characteristics

